



Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model

[List multiple models if applicable.]

HP ProCurve 3500yl-24G PoE+ Switch (J9310A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm PCA, DB24-2, POE+ (5070-6387) - 1no. PCA Aragon-2 power supply PCA(DCJ6602-05P) - 1no.	2
Batteries	All types including standard alkaline and lithium coin or button style batteries BR2032	1
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries Nil	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps Nil	0
Cathode Ray Tubes (CRT)	Nil	0
Capacitors / condensers (Containing PCB/PCT)	Nil	0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height	used in Aragon-2(DCJ6602-05P) power supply	2
External electrical cables and cords	Power cord, Console cable	2
Gas Discharge Lamps	Nil	0
Plastics containing Brominated Flame Retardants	Nil	0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations. Nil	0
Components and waste containing asbestos	Nil	0
Components, parts and materials containing	Nil	0

refractory ceramic fibers		
Components, parts and materials containing radioactive substances	Nil	0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Torx driver (standard)	T10, T15 & T20
Small adjustable wrench	5mm
Wire cutter	Medium
Hexagonal socket	3/16"

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Unfasten two captive screws from chassis and remove the Pygmy Module (if Applicable)
2. Unfasten all the screws that are fasten to the top cover with the chassis
3. Remove top cover, then remove the cover of PowerDevice (Aragon-2)
4. Disconnect all the cables.
5. Remove the screws that fasten the grounding lug to the chassis.
6. Remove all the screws that are fasten to the Power device(Aragon-2) and Main PCA in the Chassis base.
7. Unfasten the SCREW LOCK KIT-AMP HD which are used to fasten the EPS/RPS connectors.
8. Remove the Power Device (Aragon-2)
9. Unfasten the two screws from baffle and remove it.
10. Unfasten one screw from the fan tray and remove the fan tray assembly.
11. Unfasten two screws from PCA, Diamond eye and remove it
12. Remove the Light pipe
13. Then, remove the Main PCA.
14. Remove the PowerDevice(Aragon-2) insulator.
15. Disassemble the Front flap from the chassis
- 16.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

